

APT801R2AN 800V 8.0A 1.20 Ω
 APT751R2AN 750V 8.0A 1.20 Ω
 APT801R4AN 800V 7.5A 1.40 Ω
 APT751R4AN 750V 7.5A 1.40 Ω

POWER MOS IV™

N - CHANNEL ENHANCEMENT MODE HIGH VOLTAGE POWER MOSFETS

MAXIMUM RATINGS

All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	APT				UNIT
		751R2AN	801R2AN	751R4AN	801R4AN	
V _{DSS}	Drain-Source Voltage	750	800	750	800	Volts
I _D	Continuous Drain Current	8.0		7.5		Amps
I _{DM}	Pulsed Drain Current ¹	32		30		Amps
V _{GS}	Gate-Source Voltage	±30				Volts
P _D	Total Power Dissipation @ T _C = 25°C, Derate Above 25°C	198				Watts
T _J ,T _{STG}	Operating and Storage Junction Temperature Range	- 55 to 150				°C

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions / Part Number		MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage ($V_{GS} = 0V, I_D = 250 \mu A$)	APT801R2AN / APT801R4AN	800			Volts
		APT751R2AN / APT751R4AN	750			Volts
I_{DSS}	Zero Gate Voltage Drain Current ($V_{DS} = V_{DSS}, V_{GS} = 0V$)				250	μA
	($V_{DS} = 0.8 V_{DSS}, V_{GS} = 0V, T_C = 125^\circ\text{C}$)				1000	
I_{GSS}	Gate-Source Leakage Current ($V_{GS} = \pm 30V, V_{DS} = 0V$)				± 100	nA
$I_{D(ON)}$	On State Drain Current ² ($V_{DS} > I_{D(ON)} \times R_{DS(ON)}$ Max, $V_{GS} = 10V$)	APT801R2AN / APT751R2AN	8.0			Amps
		APT801R4AN / APT751R4AN	7.5			Amps
$V_{GS(TH)}$	Gate Threshold Voltage ($V_{DS} = V_{GS}, I_D = 1mA$)		2		4	Volts
$R_{DS(ON)}$	Static Drain-Source On-State Resistance ² ($V_{GS} = 10V, I_D = 0.5 I_D$ [Cont.])	APT801R2AN / APT751R2AN			1.20	Ohms
		APT801R4AN / APT751R4AN			1.40	Ohms

THERMAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\theta JC}$	Junction to Case			0.63	$^\circ\text{C/W}$
$R_{\theta JA}$	Junction to Ambient			30	$^\circ\text{C/W}$
T_L	Max. Lead Temp. for Soldering Conditions: 0.063" from Case for 10 Sec.			300	$^\circ\text{C}$

405 S.W. COLUMBIA STREET
 BEND, OREGON 97702-1035
 U.S.A.

PHONE . . . (503) 382 - 8028

FAX (503) 388 - 0364

DYNAMIC CHARACTERISTICS

APT801R2/751R2/801R4/751R4AN

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{iss}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 25V$ $f = 1 \text{ MHz}$		1500	1800	pF
C_{oss}	Output Capacitance			235	330	pF
C_{rss}	Reverse Transfer Capacitance			85	127	pF
Q_g	Total Gate Charge ³	$V_{GS} = 10V, I_D = I_D [\text{Cont.}]$ $V_{DD} = 0.5 V_{DSS}$		68	105	nC
Q_{gs}	Gate-Source Charge			7.6	11	nC
Q_{gd}	Gate-Drain ("Miller") Charge			33	49	nC
$t_d(\text{on})$	Turn-on Delay Time	$V_{DD} = 0.5 V_{DSS}$ $I_D = I_D [\text{Cont.}], V_{GS} = 15V$ $R_G = 1.8\Omega$		13	26	ns
t_r	Rise Time			15	29	ns
$t_d(\text{off})$	Turn-off Delay Time			54	81	ns
t_f	Fall Time			20	39	ns

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Symbol	Characteristic / Test Conditions / Part Number	MIN	TYP	MAX	UNIT
I_S	Continuous Source Current (Body Diode)	APT801R2AN / APT751R2AN		8.0	Amps
		APT801R4AN / APT751R4AN		7.5	Amps
I_{SM}	Pulsed Source Current ¹ (Body Diode)	APT801R2AN / APT751R2AN		32	Amps
		APT801R4AN / APT751R4AN		30	Amps
V_{SD}	Diode Forward Voltage ² ($V_{GS} = 0V, I_S = -I_D [\text{Cont.}]$)			1.3	Volts
t_{rr}	Reverse Recovery Time ($I_S = -I_D [\text{Cont.}], dI_S/dt = 100A/\mu s$)	240	480	960	ns
Q_{rr}	Reverse Recovery Charge	1.7	3.4	7	μC

SAFE OPERATING AREA CHARACTERISTICS

Symbol	Characteristic	Test Conditions / Part Number	MIN	TYP	MAX	UNIT
SOA1	Safe Operating Area	$V_{DS} = 0.4 V_{DSS}, I_{DS} = P_D / 0.4 V_{DSS}, t = 1 \text{ Sec.}$	198			Watts
SOA2	Safe Operating Area	$I_{DS} = I_D [\text{Cont.}], V_{DS} = P_D / I_D [\text{Cont.}], t = 1 \text{ Sec.}$	198			Watts
I_{LM}	Inductive Current Clamped	APT801R2AN / APT751R2AN	32			Amps
		APT801R4AN / APT751R4AN	30			Amps

1.) Repetitive Rating: Pulse width limited by maximum junction temperature. See Transient Thermal Impedance Curve. (Fig.1)

2.) Pulse Test: Pulse width < 380 μs
Duty Cycle < 2%
3.) See MIL-STD-750 Method 3471

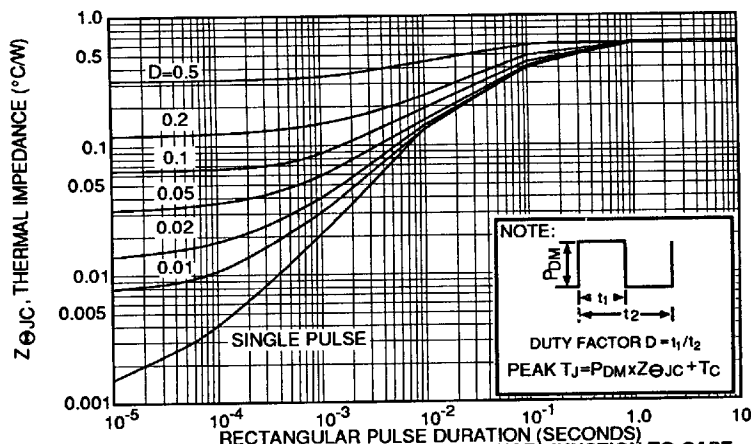
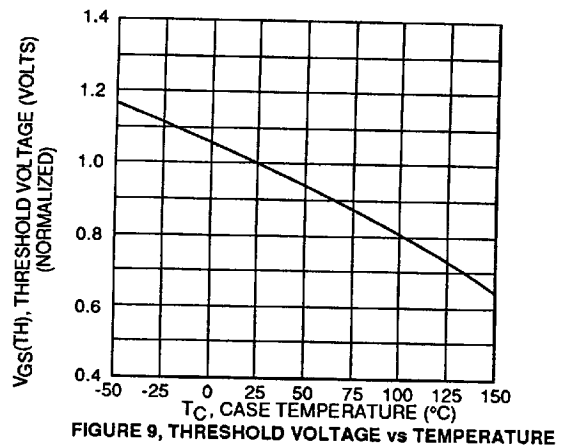
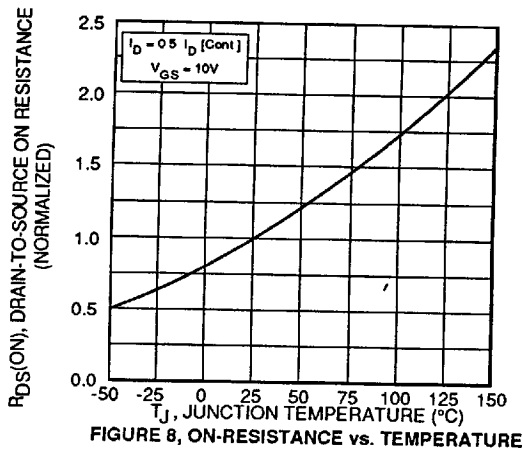
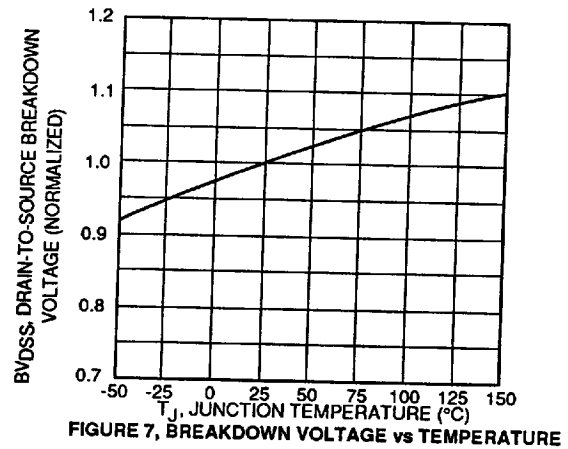
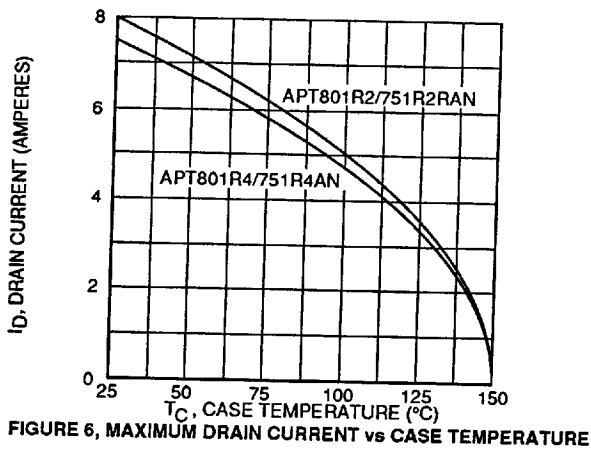
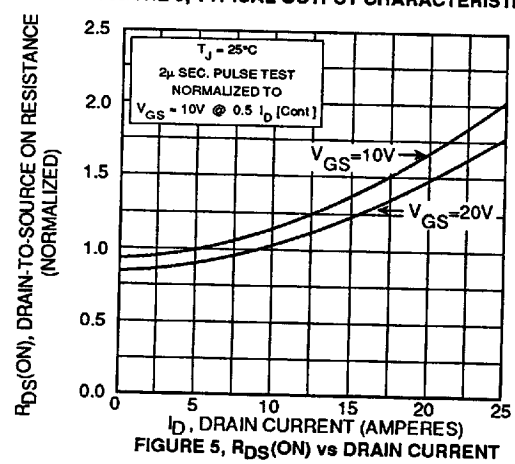
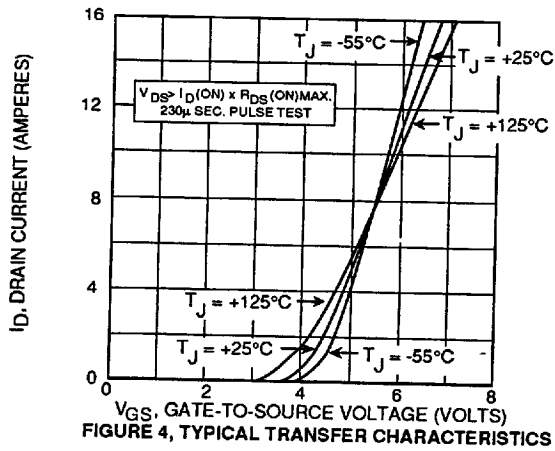
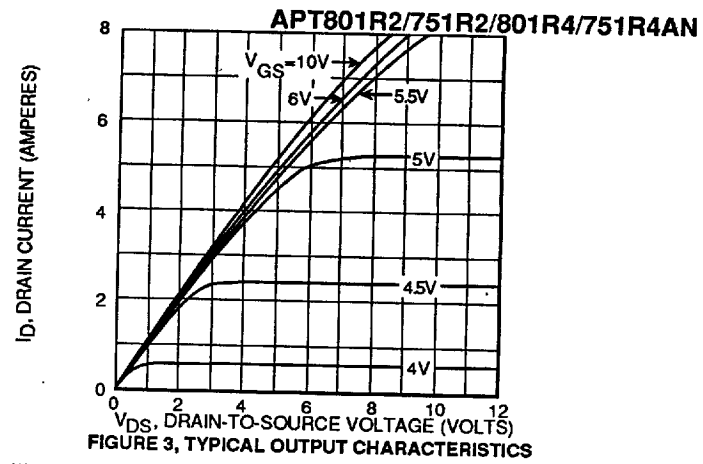
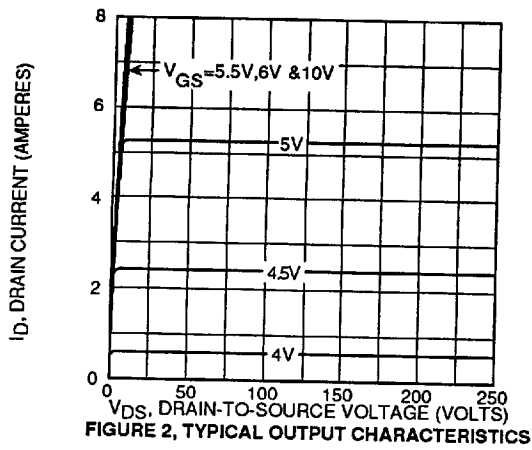
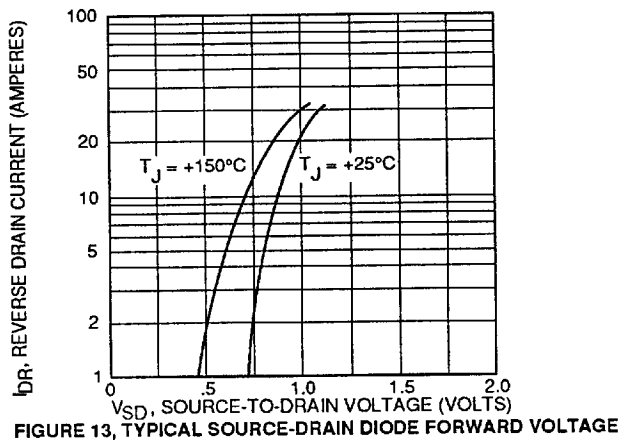
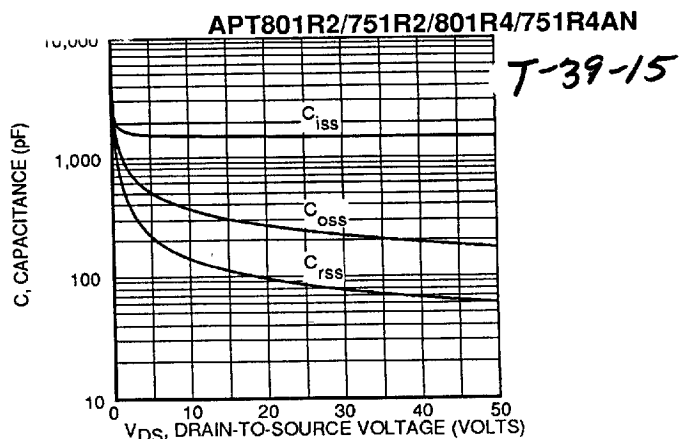
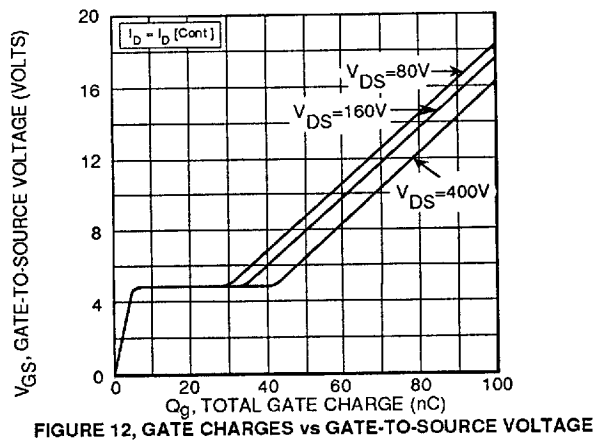
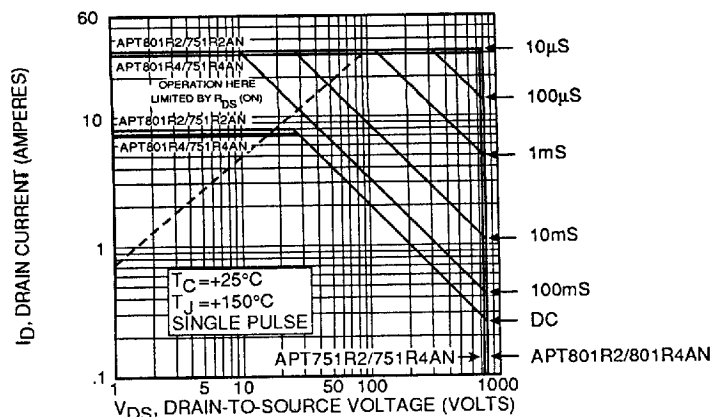
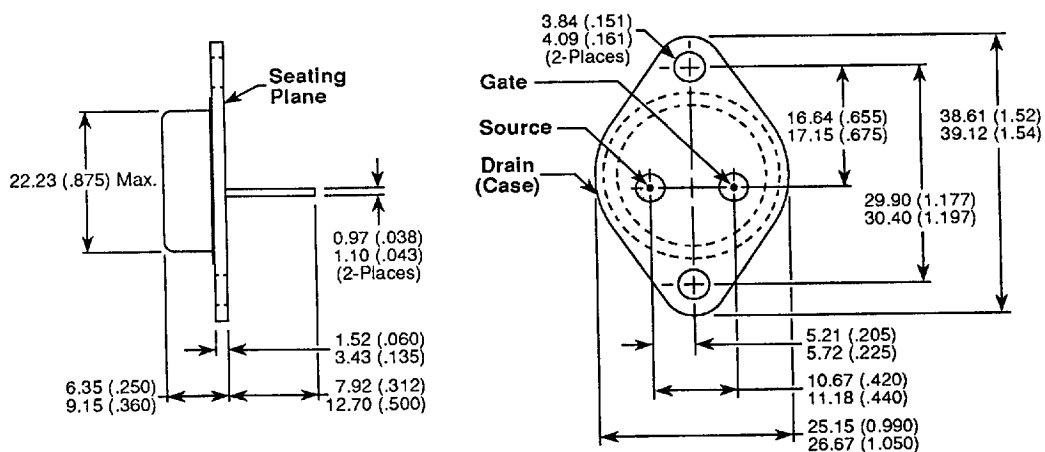


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION





TO-3 Package Outline (TO-204AA)



Dimensions in Millimeters and (Inches)